Photocouplers Optically Isolation Amplifiers

TLP7820

1. Applications

- · Motor phase and rail current sensing
- · Power inverter current and voltage sensing

2. General

The TLP7820 of isolation amplifiers is designed for current sensing in electronic motor drives. In a typical implementation, motor currents flow through an external resistor and the resulting analog voltage drop is sensed by the TLP7820.

3. Features

- (1) Output side supply voltage: 3 to 5.5 V
- (2) Output side supply current: 6.2 mA (typ.)
- (3) Operating temperature range: -40 to 105 °C
- (4) Common-mode transient immunity: 15 kV/µs (min)
- (5) Safety standards

UL-approved: UL1577, File No.E67349

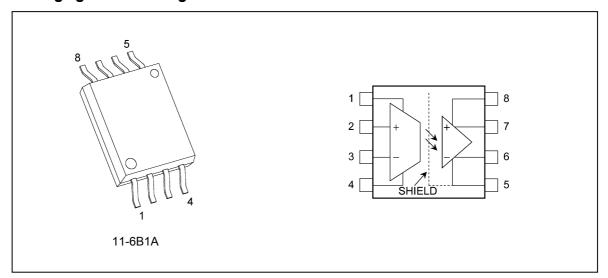
cUL-approved: CSA Component Acceptance Service No.5A File No.E67349

VDE-approved: EN60747-5-5, EN60065 or EN60950-1 (Note 1)

Note1: When a VDE approved type is needed, please designate the **Option (D4)**.



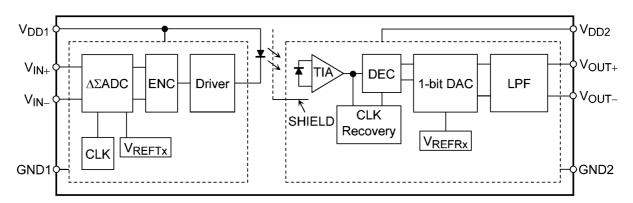
4. Packaging and Pin Assignment



4.1. Pin Assignment

Pin No.	Symbol	Description
1	V_{DD1}	Input side supply voltage
2	V _{IN+}	Positive input
3	V _{IN-}	Negative input
4	GND1	Input side ground
5	GND2	Output side ground
6	V _{OUT-}	Negative output
7	V _{OUT+}	Positive output
8	V_{DD2}	Output side supply voltage

5. Internal Circuit (Note)



Note: A 0.1- μ F bypass capacitor must be connected between 1 and 4 pins and between 5 and 8 pins.

6. Principle of Operation

6.1. Mechanical Parameters

Characteristics	SO8L	Unit
Height	2.3 (Max)	mm
Creepage distances	8.0 (Min)	
Clearance	8.0 (Min)	
Internal isolation thickness	0.4 (Min)	



7. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Rating	Unit	
Supply Voltages		V_{DD1}, V_{DD2}		-0.5 to 6	V
Steady-state input voltages		V _{IN+} , V _{IN-}		-0.5 to V _{DD1} + 0.5	
Two-second transient input voltages		V_{IN+}, V_{IN-}		-6 to V _{DD1} + 0.5	
Input power dissipation		P _D	(Note1)	72	mW
Output voltages		V _{OUT+} , V _{OUT-}		-0.5 to V _{DD2} + 0.5	V
Output power dissipation		Po	(Note1)	60	mW
Operating temperature		T _{opr}		-40 to 105	°C
Storage temperature		T _{stg}		-55 to 125	°C
Lead soldering temperature	(10 s)	T _{sol}	(Note2)	260	°C
Isolation voltage	AC, 60 s, R.H. ≤ 60 %	BV _S	(Note3)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: Ceramic capacitors $(0.1 \, \mu F)$ should be connected between 1 and 4 pins and between 5 and 8 pins to stabilize the operation. Otherwise, this photocoupler may not switch properly. The bypass capacitors should be placed as close as possible to each pin.

Note1: Input power dissipation derating ($T_a \ge 110.6~^{\circ}C$): -5.0 mW/ $^{\circ}C$ Output power dissipation derating ($T_a \ge 113.0~^{\circ}C$): -5.0 mW/ $^{\circ}C$

Note2: ≥ 2 mm below seating plane.

Note3: This device is considered as a two-terminal device: Pins 1, 2, 3 and 4 are shorted together, and pins 5, 6, 7 and 8 are shorted together.

8. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Input side supply voltage	V_{DD1}		4.5	5	5.5	V
Output side supply voltage	V _{DD2}		3	_	5.5	
Analog input voltage	V _{IN+} , V _{IN-}	(Note 1), (Note 2)	-200	_	200	mV
Ambient temperature	T _a		-40	_	105	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

Note 1: FSR = ± 300 mV

Note 2: When either V_{IN+} or V_{IN-} or both are equal to or greater than V_{DD1} - 2 V (e.g., if V_{DD1} = 5 V, when V_{IN+} and/or V_{IN-} are equal to or greater than 5 V - 2 V = 3 V), isolation amplifiers go into one of the test modes. Do not raise either V_{IN+} or V_{IN-} above this voltage to keep the device in functional mode.



9. Electrical Characteristics

9.1. DC Characteristics (Unless otherwise specified, T_a = -40 to 105 °C, V_{DD1} = 4.5 to 5.5 V, V_{DD2} = 3 to 5.5 V, V_{IN+} = -200 to 200 mV, V_{IN-} = 0 V)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	Vos		T _a = 25 °C	-0.6	0.9	2.4	mV
Input offset voltage drift vs ambient temperature	dV _{OS} /dT _a			_	2	6	μV/°C
Input offset voltage drift vs input side supply voltage	$ dV_{OS}/dV_{DD1} $			l	120	l	μV/V
Gain (Rank B)	G ₀	(Note 1)	T _a = 25 °C	8.16	8.2	8.24	V/V
Gain (Rank A)	G ₁	(Note 1)	T _a = 25 °C	8.12	8.2	8.28	
Gain (None)	G ₃	(Note 1)	T _a = 25 °C	7.95	8.2	8.44	
Gain drift vs ambient temperature	dG/dT _a			_	0.00012	_	V/V/°C
V _{OUT} non-linearity (±200 mV)	NL ₂₀₀	(Note 2)	V _{IN+} = -200 to 200 mV, T _a = 25 °C	_	0.02	0.13	%
V_{OUT} non-linearity (± 200 mV) drift vs ambient temperature	dNL ₂₀₀ /dT _a			_	0.00007	_	%/°C
V _{OUT} non-linearity (±100 mV)	NL ₁₀₀	(Note 2)	V _{IN+} = -100 to 100 mV, T _a = 25 °C	_	0.01	0.06	%
High-level output voltage	V _{OH}		V _{IN+} = 400 mV, T _a = 25 °C	_	2.497	_	V
Low-level output voltage	V _{OL}		V _{IN+} = -400 mV, T _a = 25 °C	_	0.0009	_	1
Input common-mode rejection ratio	CMRR _{IN}			_	80	_	dB
Input bias current	I _{IN+}		V _{IN+} = 0 V, T _a = 25 °C	-1	-0.055		μА
Input side supply current (V _{DD1})	I _{DD1}		V _{IN+} = 0 V	_	8.6	12	mA
Output side supply current (V _{DD2})	I _{DD2}		V _{IN+} = 0 V	_	6.2	10	
Equivalent input resistance	R _{IN}			_	80		kΩ

Note 1: See section 9.1.1. for gain rank values.

Note 2: The slope of the optimum line is derived by the method of least squares between differential input voltage $(V_{IN+} - V_{IN-})$ and differential output voltage $(V_{OUT+} - V_{OUT-})$. Nonlinearity is defined as a fraction of the half of the peak-to-peak value of differential output voltage deviation divided by the full-scale differential output voltage (OVR).

9.1.1. Gain Rank (Note) (Unless otherwise specified, T_a = 25 °C)

Rank	Gain Rank Marking	(Min)	Gain (Typ.)	(Max)	Unit
None (±3 %)	Blank, A, B	7.95	8.2	8.44	V/V
Rank A (±1 %)	A, B	8.12	8.2	8.28	
Rank B (±0.5 %)	В	8.16	8.2	8.24	

Note: The gain is defined as the slope of the optimum line derived by the method of least squares between differential input voltage (V_{IN+} - V_{IN-}) and differential output voltage (V_{OUT+} - V_{OUT-}) in the recommended voltage range.

Note: Specify both the part number and a rank in this format when ordering. Example: Rank B: TLP7820(B



10. AC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 105 °C, V_{DD1} = 4.5 to 5.5 V, V_{DD2} = 3 to 5.5 V)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
V _{OUT} bandwidth (-3 dB)	f _{-3dB}	V_{IN+} = 400 m V_{p-p} , sine wave	140	230	_	kHz
V_{IN} to V_{OUT} propagation delay time (10 %-10 %)	t _{pD10}	$V_{\text{IN+}}$ = 0 to 200 mV/ μ s step C _L = 15 pF	_	1.9	2.3	μS
V_{IN} to V_{OUT} propagation delay time (50 %-50 %)	t _{pD50}		_	2.3	2.6	
V_{IN} to V_{OUT} propagation delay time (90 %-90 %)	t _{pD90}		_	2.8	3.3	
V _{OUT} rise time	t _r		_	1.7	_	
V _{OUT} fall time	t _f		_	1.7	_	
Common-mode transient immunity	CMTI	V _{CM} = 1 kV, T _a = 25 °C	15	20	_	kV/μs

Note: All typical values are at $T_a = 25$ °C.

11. Isolation Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Note Test Condition		Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _S = 0 V, f = 1 MHz		1.0		pF
Isolation resistance	R _S	(Note 1)	V _S = 500 V, R.H. ≤ 60 %	1 × 10 ¹²	1014		Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	5000			Vrms
			AC, 1 s in oil		10000		
			DC, 60 s in oil	_	10000	_	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1, 2, 3 and 4 are shorted together, and pins 5, 6, 7 and 8 are shorted together.

C_L is approximately 15 pF which includes probe and stray wiring capacitance.



12. Characteristics Curves (Note)

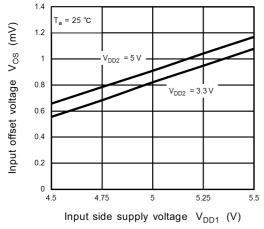


Fig. 12.1 Vos - VDD1

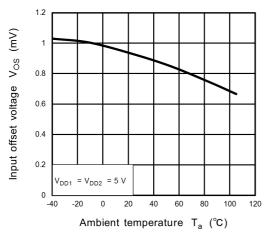


Fig. 12.3 Vos - Ta

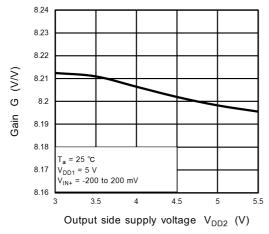


Fig. 12.5 G - V_{DD2}

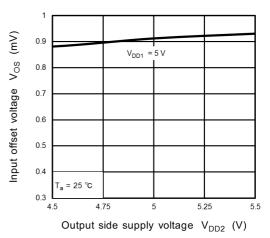


Fig. 12.2 V_{OS} - V_{DD2}

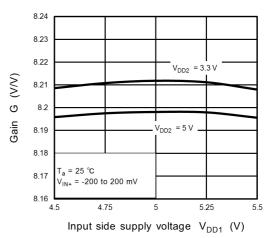


Fig. 12.4 G - V_{DD1}

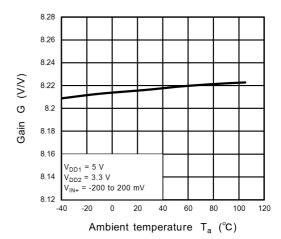


Fig. 12.6 G-Ta

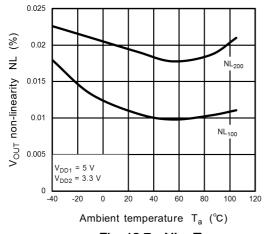


Fig. 12.7 NL - Ta

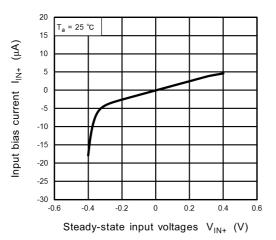


Fig. 12.9 I_{IN+} - V_{IN+}

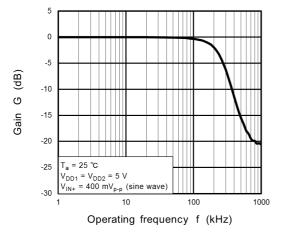


Fig. 12.11 G[dB] - f

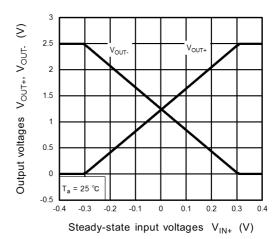


Fig. 12.8 V_{OUT} - V_{IN+}

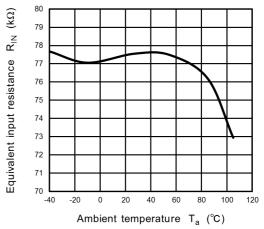


Fig. 12.10 R_{IN} - T_a

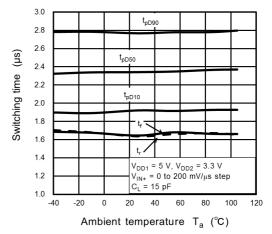


Fig. 12.12 Switching Time - Ta

Rev.6.0

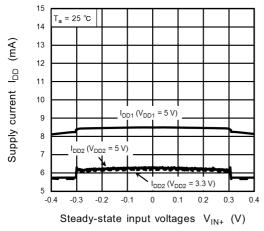


Fig. 12.13 I_{DD} - V_{IN+}

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



13. Soldering and Storage

13.1. Precautions for Soldering

The soldering temperature should be controlled as closely as possible to the conditions shown below, irrespective of whether a soldering iron or a reflow soldering method is used.

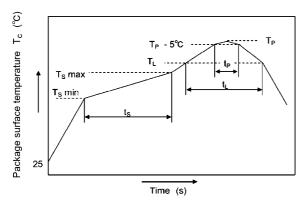
When using soldering reflow.

The soldering temperature profile is based on the package surface temperature.

(See the figure shown below, which is based on the package surface temperature.)

Reflow soldering must be performed once or twice.

The mounting should be completed with the interval from the first to the last mountings being 2 weeks.



	Symbol	Min	Max	Unit
Preheat temperature	Ts	150	200	°C
Preheat time	ts	60	120	s
Ramp-up rate (T _L to T _P)			3	°C/s
Liquidus temperature	TL	2	17	°C
Time above T _L	t∟	60	150	s
Peak temperature	T _P		260	°C
Time during which T_c is between $(T_P - 5)$ and T_P	t _P		30	s
Ramp-down rate (T _P to T _L)			6	°C/s

Fig. 13.1.1 (Pb)-free solder is used

· When using soldering flow

Preheat the device at a temperature of 150 $^{\circ}\text{C}$ (package surface temperature) for 60 to 120 seconds.

Mounting condition of 260 °C within 10 seconds is recommended.

Flow soldering must be performed once.

· When using soldering Iron

Complete soldering within 10 seconds for lead temperature not exceeding 260 °C or within 3 seconds not exceeding 350 °C

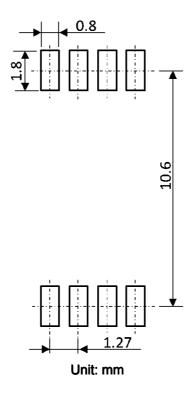
Heating by soldering iron must be done only once per lead.

13.2. Precautions for General Storage

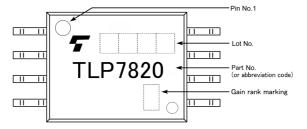
- Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- Follow the precautions printed on the packing label of the device for transportation and storage.
- Keep the storage location temperature and humidity within a range of 5 °C to 35 °C and 45 % to 75 %, respectively.
- Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- · When restoring devices after removal from their packing, use anti-static containers.
- · Do not allow loads to be applied directly to devices while they are in storage.
- If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.



14. Land Pattern Dimensions (for reference only)



15. Marking





16. EN60747-5-5 Option (D4) Specification

• Part number: TLP7820 (Note 1)

• The following part naming conventions are used for the devices that have been qualified according to option (D4) of EN60747.

Example: TLP7820(D4A,TL,E(O

D4: EN60747 option

A: Gain rank TL: Tape type

E: [[G]]/RoHS COMPATIBLE (Note 2)

O: Domestic ID (Country/Region of origin: Japan)

Note1: Use TOSHIBA standard type number for safety standard application.

e.g., TLP7820(D4A,TL,E(O \rightarrow TLP7820

Note2: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

Description	Symbol	Rating	Unit
Application classification			
for rated mains voltage \leq 150 Vrms for rated mains voltage \leq 300 Vrms		I-IV I-III	_
Climatic classification		55 / 125 / 21	_
Pollution degree		2	_
Maximum operating insulation voltage	VIORM	1230	Vpeak
Input to output test voltage, Method A $V_{pr} = 1.6 \times V_{IORM}, \text{ type and sample test} \\ t_p = 10 \text{ s, partial discharge} < 5 \text{ pC}$	V _{pr}	1970	Vpeak
Input to output test voltage, Method B $V_{pr} = 1.875 \times V_{IORM}, \ 100 \ \% \ production \ test$ $t_p = 1 \ s, \ partial \ discharge < 5 \ pC$	V _{pr}	2310	Vpeak
Highest permissible overvoltage (transient overvoltage, t _{pr} = 60 s)	V _{TR}	8000	Vpeak
Safety limiting values (max. permissible ratings in case of fault, also refer to thermal derating curve) current (input current I _F , P _{so} = 0) power (output or total power dissipation) temperature	I _{si} P _{so} T _s	250 400 150	mA mW °C
Insulation resistance V_{IO} = 500 V, T_a = 25 °C V_{IO} = 500 V, T_a = 100 °C V_{IO} = 500 V, T_a = T_s	R _{si}	≥ 10 ¹² ≥ 10 ¹¹ ≥ 10 ⁹	Ω

Fig. 16.1 EN60747 Insulation Characteristics



Minimum creepage distance	Cr	8.0 mm
Minimum clearance	CI	8.0 mm
Minimum insulation thickness	ti	0.4 mm
Comparative tracking index	CTI	175

Fig. 16.2 Insulation Related Specifications (Note)

Note: This photocoupler is suitable for **safe electrical isolation** only within the safety limit data.

Maintenance of the safety data shall be ensured by means of protective circuits.



Fig. 16.3 Marking on Packing for EN60747

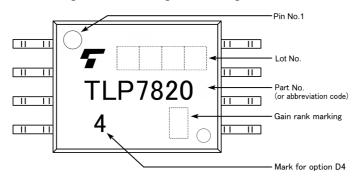
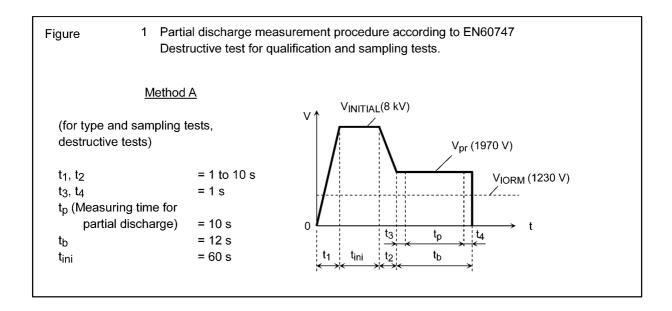
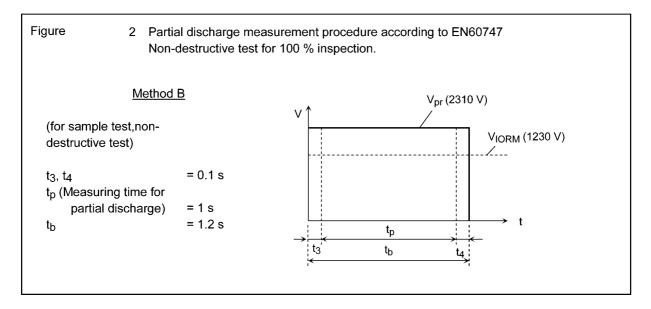


Fig. 16.4 Marking Example (Note)

Note: The above marking is applied to the photocouplers that have been qualified according to option (D4) of EN60747.





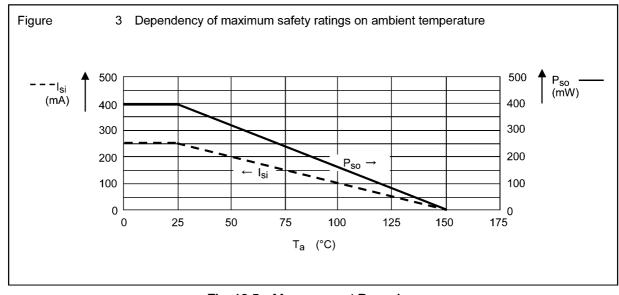


Fig. 16.5 Measurement Procedure



17. Embossed-Tape Packing (TL) Specification for Mini-Flat Photocouplers

17.1. Applicable Package

Package Name	Product Type
SO8L	Long creepage mini flat coupler

17.2. Product Naming Conventions

Type of package used for shipment is denoted by a symbol suffix after a part number. The method of classification is as below.

Example) TLP7820(A,TL,E(O

Part number: TLP7820

Gain rank : A Tape type : TL

[[G]]/RoHS COMPATIBLE : E (Note 1)

Domestic ID (Country/Region of origin: Japan): O

Note 1: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

17.3. Tape Dimensions Specification

Tape type	Quantity (pcs/reel)
TL	1500

17.3.1. Orientation of Device in Relation to Direction of Feed

Device orientation in the carrier cavities as shown in the following figure.

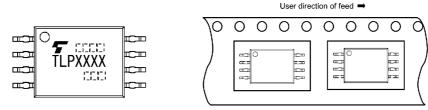


Fig. 17.3.1.1 Device Orientation

17.3.2. Empty Cavities

Characteristics	Criterion	Remarks
Occurrences of 2 or more successive empty cavities	0 device	Within any given 40-mm section of tape, not including leader and trailer
Single empty cavity	6 devices (max) per reel	Not including leader and trailer

17.3.3. Tape Leader and Trailer

The start end of the tape has 50 or more empty cavities. The hub end of the tape has 50 or more empty cavities and two empty turns only for a cover tape.



17.3.4. Tape Dimensions

Tape material: Plastic (for protection against static electricity)

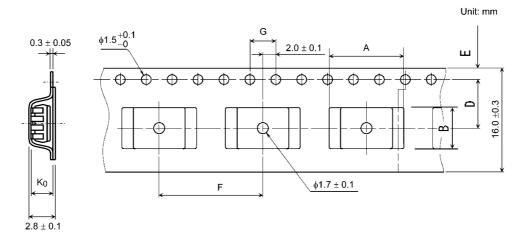


Table Tape Dimensions (unit: mm, unless otherwise specified : ±0.1)

Symbol	Dimension	Remark
Α	11.55	_
В	6.35	_
D	7.5	Center line of embossed cavity and sprocket hole
Е	1.75	Distance between tape edge and sprocket hole center
F	16.0	Cumulative error +0.1/-0.3 (max) per 10 empty cavities holes
G	4.0	Cumulative error +0.1/-0.3 (max) per 10 sprocket holes
K ₀	2.4	Internal space



17.3.5. Reel Specification

Material: Plastic

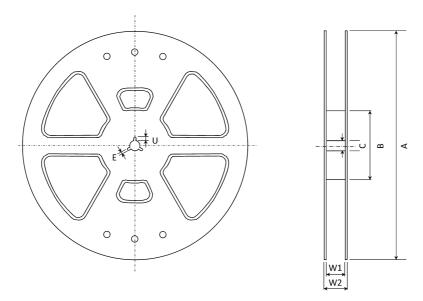
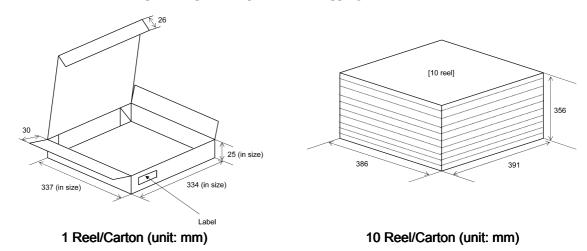


Table Reel Dimensions (unit: mm)

Symbol	Dimension
Α	$\phi 330 \pm 2$
В	φ100 ± 1
С	ф13 ± 0.5
E	2.0 ± 0.5
U	4.0 ± 0.5
W1	17.4 ± 1.0
W2	21.4 ± 1.0

17.4. Packing (Note)

Either one reel or ten reels of photocouplers are packed in a shipping carton.



Note: Taping reel diameter: \$\phi 330 mm

17.5. Label Format

- (1) Carton: The label provides the part number, quantity, lot number, the Toshiba logo, etc.
- (2) Reel: The label provides the part number, the taping name, quantity, lot number, etc.



17.6. Ordering Information

When placing an order, please specify the part number, Gain rank, tape type and quantity as shown in the following example.

Example) TLP7820(A,TL,E(O 1500 pcs

Part number: TLP7820

Gain rank : A
Tape type : TL

[[G]]/RoHS COMPATIBLE : E (Note 1)

Domestic ID (Country/Region of origin: Japan): O

Quantity (must be a multiple of 1500 pcs): 1500 pcs

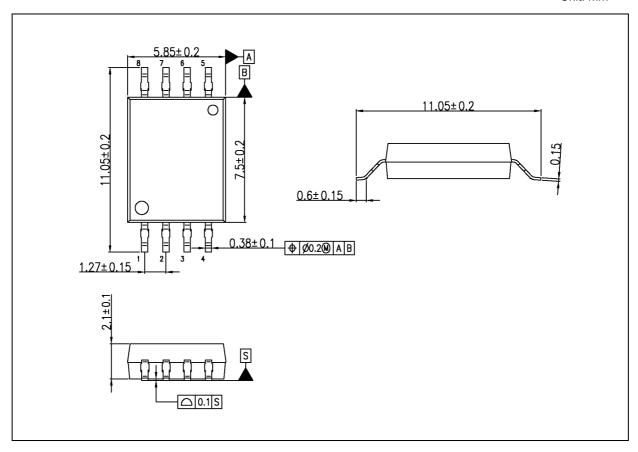
Note 1: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.



Package Dimensions

Unit: mm



Weight: 0.205 g (typ.)

Package Name(s)		
TOSHIBA: 11-6B1A		



RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications.
 TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
 EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY
 CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
 ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation,
 equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles,
 trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices,
 elevators and escalators, devices related to electric power, and equipment used in finance-related fields. IF YOU USE PRODUCT FOR
 UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your TOSHIBA sales
 representative.
- · Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any
 infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any
 intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
 FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER,
 INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING
 WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND
 (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT,
 OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR
 PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor.
 Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
 Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Transistor Output Optocouplers category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below:

LTV-814S-TA LTV-815S-TA LTV-8241S LTV-824HS LTV-852S 635549D 66095-001 6N136-X017T 6N136-X019T 717126G MCT6-X007 MCT6-X007T MOC8101-X009 MOC8101-X017T PS2561-1-A PS2561A-1-W-A PS2561AL1-1-V-W-A PS2561B-1-L-A PS2561DL-1Y-V-A PS2561L1-1-A PS2561L-1-V-A PS2581AL2-A PS2705-1-L-A PS2706-1-A PS2802-1-F3-K-A PS2815-1-A MRF658 IL755-1X007 IL755-2 ILD2-X006 ILD74-X001 ILQ615-2X017 ILQ615-3X016 LDA102S LDA110S LDA202 SFH601-4X007T SFH615A-2X009T SFH615A-4X001 SFH615AGR-X007T SFH618A-3X006 SFH620A-2X007 SFH690BT3 PS2501AL-1-F3-W-A PS2561-1-V-W-A PS2561AL-1-V-A PS2561AL-1-V-A PS2561AL-1-V-A PS2561AL-1-V-A PS2561AL-1-V-A PS2561AL-1-V-A PS2561AL-1-V-A PS2561BL-1-F3-Q-A